## ADC12040

## 12－Bit， 40 MSPS， 340 mW A／D Converter with Internal Sample－and－Hold

## General Description

The ADC12040 is a monolithic CMOS analog－to－digital con－ verter capable of converting analog input signals into 12－bit digital words at 40 Megasamples per second（MSPS），mini－ mum．This converter uses a differential，pipeline architecture with digital error correction and an on－chip sample－and－hold circuit to minimize die size and power consumption while providing excellent dynamic performance．Operating on a single 5 V power supply，this device consumes just 340 mW at 40 MSPS，including the reference current．The Power Down feature reduces power consumption to 40 mW ．
The differential inputs provide a full scale input swing equal to $\mathrm{V}_{\text {REF }}$ with the possibility of a single－ended input．Full use of the differential input is recommended for optimum perfor－ mance．For ease of use，the buffered，high impedance， single－ended reference input is converted on－chip to a differ－ ential reference for use by the processing circuitry．Output data format is 12－bit offset binary．
This device is available in the 32－lead LQFP package and will operate over the industrial temperature range of $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ ．

## Features

－Single supply operation
－Internal sample－and－hold
－Outputs 2.5 V to 5 V compatible
－TTL／CMOS compatible input／outputs
－Low power consumption
－Power down mode
－On－chip reference buffer

## Key Specifications

－Resolution
12 Bits
－Conversion Rate
40 MSPS（min）
－DNL $\pm 0.4$ LSB（typ）
－INL
$\pm 0.7$ LSB（typ）
69 dB（typ）
11.2 bits（typ）

6 Clock Cycles
$+5 \mathrm{~V} \pm 5 \%$
340 mW （typ）

## Applications

－Ultrasound and Imaging
－Instrumentation
－Cellular Base Stations／Communications Receivers
－Sonar／Radar
－xDSL
－Wireless Local Loops／Cable Modems
－HDTV／DTV
－DSP Front Ends

## Connection Diagram



## Ordering Information

| Industrial $\left(\mathbf{- 4 0}{ }^{\circ} \mathbf{C} \leq \mathbf{T}_{\mathbf{A}} \leq \mathbf{+ 8 5}{ }^{\circ} \mathrm{C}\right)$ | Package |
| :---: | :---: |
| ADC12040CIVY | 32 Pin LQFP |
| ADC12040CIVYX | 32 Pin LQFP Tape and Reel |
| ADC12040EVAL | Evaluation Board |

Block Diagram


Pin Descriptions and Equivalent Circuits


## Pin Descriptions and Equivalent Circuits (Continued)

| Pin No. | Symbol | Equivalent Circuit | Description |
| :---: | :---: | :---: | :---: |
| $\begin{aligned} & 14-19, \\ & 22-27 \end{aligned}$ | D0-D11 |  | Digital data output pins that make up the 12-bit conversion results. D0 is the LSB, while D11 is the MSB of the offset binary output word. Output levels are TTL/CMOS compatible. |
| ANALOG POWER |  |  |  |
| 5, 6, 29 | $\mathrm{V}_{\text {A }}$ |  | Positive analog supply pins. These pins should be connected to a quiet +5 V voltage source and bypassed to AGND with $0.1 \mu \mathrm{~F}$ monolithic capacitors located within 1 cm of these power pins, and with a $10 \mu \mathrm{~F}$ capacitor. |
| 4, 7, 28 | AGND |  | The ground return for the analog supply. |
| DIGITAL POWER |  |  |  |
| 13 | $\mathrm{V}_{\mathrm{D}}$ |  | Positive digital supply pin. This pin should be connected to the same quiet +5 V source as is $\mathrm{V}_{\mathrm{A}}$ and bypassed to DGND with a $0.1 \mu \mathrm{~F}$ monolithic capacitor in parallel with a $10 \mu \mathrm{~F}$ capacitor, both located within 1 cm of the power pin. |
| 9, 12 | DGND |  | The ground return for the digital supply. |
| 21 | $V_{\text {DR }}$ |  | Positive digital supply pin for the ADC12040's output drivers. This pin should be connected to a voltage source of +2.5 V to +5 V and bypassed to DR GND with a $0.1 \mu \mathrm{~F}$ monolithic capacitor. If the supply for this pin is different from the supply used for $\mathrm{V}_{\mathrm{A}}$ and $\mathrm{V}_{\mathrm{D}}$, it should also be bypassed with a $10 \mu \mathrm{~F}$ tantalum capacitor. $V_{D R}$ should never exceed the voltage on $V_{D}$. All bypass capacitors should be located within 1 cm of the supply pin. |
| 20 | DR GND |  | The ground return for the digital supply for the ADC12040's output drivers. This pin should be connected to the system digital ground, but not be connected in close proximity to the ADC12040's DGND or AGND pins. See Section 5 (Layout and Grounding) for more details. |

## Absolute Maximum Ratings (Notes 1,

2) 

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/ Distributors for availability and specifications.

| $V_{A}, V_{D}, V_{D R}$ | 6.5 V |
| :--- | ---: |
| $\left\|V_{A}-V_{D}\right\|$ | $\leq 100 \mathrm{mV}$ |
| Voltage on Any Input or Output Pin | -0.3 V to $\left(\mathrm{V}_{\mathrm{A}}\right.$ or $\mathrm{V}_{\mathrm{D}}$ |
|  | $+0.3 \mathrm{~V})$ |
| Input Current at Any Pin (Note 3) | $\pm 25 \mathrm{~mA}$ |
| Package Input Current (Note 3) | $\pm 50 \mathrm{~mA}$ |
| Package Dissipation at $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ | See (Note 4) |
| ESD Susceptibility |  |
| $\quad$ Human Body Model (Note 5) | 2500 V |
| $\quad$ Machine Model (Note 5) | 250 V |
| Soldering Temperature, |  |
| $\quad$ Infrared, 10 sec. (Note 6) | $235^{\circ} \mathrm{C}$ |
| Storage Temperature | $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ |

Operating Ratings (Notes 1,2$)$

| Operating Temperature | $-40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C}$ |
| :--- | ---: |
| Supply Voltage $\left(\mathrm{V}_{\mathrm{A}}, \mathrm{V}_{\mathrm{D}}\right)$ | +4.75 V to +5.25 V |
| Output Driver Supply $\left(\mathrm{V}_{\mathrm{DR}}\right)$ | +2.35 V to $\mathrm{V}_{\mathrm{D}}$ |
| $\mathrm{V}_{\text {REF }}$ Input | 1.0 V to 2.2 V |
| CLK, PD, $\overline{\mathrm{OE}}$ | -0.05 V to $\left(\mathrm{V}_{\mathrm{D}}+0.05 \mathrm{~V}\right)$ |
| $\mathrm{V}_{\text {IN }}$ Input | -0 V to $\left(\mathrm{V}_{\mathrm{A}}-0.5 \mathrm{~V}\right)$ |
| IAGND-DGNDI | $\leq 100 \mathrm{mV}$ |

## Converter Electrical Characteristics

Unless otherwise specified, the following specifications apply for AGND = DGND = DR GND $=0 \mathrm{~V}, \mathrm{~V}_{A}=\mathrm{V}_{\mathrm{D}}=+5 \mathrm{~V}, \mathrm{~V}_{\mathrm{DR}}=$ $+3.0 \mathrm{~V}, \mathrm{PD}=0 \mathrm{~V}, \mathrm{~V}_{\text {REF }}=+2.0 \mathrm{~V}, \mathrm{f}_{\text {CLK }}=40 \mathrm{MHz}, \mathrm{t}_{\mathrm{r}}=\mathrm{t}_{\mathrm{f}}=3 \mathrm{~ns}, \mathrm{C}_{\mathrm{L}}=20 \mathrm{pF} /$ pin. Boldface limits apply for $\mathrm{T}_{\mathrm{A}}=\mathrm{T}_{\mathrm{J}}=\mathrm{T}_{\text {MIN }}$ to $\mathrm{T}_{\text {MAX }}$ : all other limits $\mathrm{T}_{\mathrm{A}}=\mathrm{T}_{\mathrm{J}}=25^{\circ} \mathrm{C}$ (Notes 7, 8, 9)

| Symbol | Parameter | Conditions | Typical (Note 10) | Limits (Note 10) | Units (Limits) |
| :---: | :---: | :---: | :---: | :---: | :---: |
| STATIC CONVERTER CHARACTERISTICS |  |  |  |  |  |
|  | Resolution with No Missing Codes |  |  | 12 | Bits (min) |
| INL | Integral Non Linearity (Note 11) |  | $\pm 0.7$ | $\pm 1.8$ | LSB (max) |
| DNL | Differential Non Linearity |  | $\pm 0.4$ | $\pm 1.0$ | LSB (max) |
| GE | Gain Error |  | $\pm 0.1$ | $\pm 2.1$ | \%FS (max) |
|  | Offset Error ( $\mathrm{V}_{\mathrm{IN}^{+}}=\mathrm{V}_{\mathrm{IN}^{-}}$) |  | -0.1 | $\pm 0.9$ | \%FS (max) |
|  | Under Range Output Code |  | 0 | 0 |  |
|  | Over Range Output Code |  | 4095 | 4095 |  |
| DYNAMIC CONVERTER CHARACTERISTICS |  |  |  |  |  |
| FPBW | Full Power Bandwidth | 0 dBFS Input, Output at -3 dB | 100 |  | MHz |
| SNR | Signal-to-Noise Ratio | $\mathrm{f}_{\text {IN }} 1 \mathrm{MHz}, \mathrm{V}_{\text {IN }}-0.5 \mathrm{dBFS}$ | 70 |  | dB |
|  |  | $\mathrm{f}_{\text {IN }}=10 \mathrm{MHz}, \mathrm{V}_{\text {IN }}=-0.5 \mathrm{dBFS}$ | 69.5 | 66.5 | dB (min) |
| SINAD | Signal-to-Noise and Distortion | $\mathrm{f}_{\mathrm{IN}}=1 \mathrm{MHz}, \mathrm{V}_{\mathrm{IN}}=-0.5 \mathrm{dBFS}$ | 69.5 |  | dB |
|  |  | $\mathrm{f}_{\mathrm{IN}}=10 \mathrm{MHz}, \mathrm{V}_{\text {IN }}=-0.5 \mathrm{dBFS}$ | 69 | 66 | dB (min) |
| ENOB | Effective Number of Bits | $\mathrm{f}_{\text {IN }}=1 \mathrm{MHz}, \mathrm{V}_{\text {IN }}=-0,5 \mathrm{dBFS}$ | 11.2 |  | Bits |
|  |  | $\mathrm{f}_{\mathrm{IN}}=10 \mathrm{MHz}, \mathrm{V}_{\text {IN }}=-0,5 \mathrm{dBFS}$ | 11.2 | 10.7 | Bits (min) |
| THD | Total Harmonic Distortion | $\mathrm{f}_{\mathrm{IN}}=1 \mathrm{MHz}, \mathrm{V}_{\mathrm{IN}}=-0,5 \mathrm{dBFS}$ | -82 |  | dB |
|  |  | $\mathrm{f}_{\mathrm{IN}}=10 \mathrm{MHz}, \mathrm{V}_{\text {IN }}=-0,5 \mathrm{dBFS}$ | -80 | -67 | dB (max) |
| SFDR | Spurious Free Dynamic Range | $\mathrm{f}_{\text {IN }}=1 \mathrm{MHz}, \mathrm{V}_{\text {IN }}=-0,5 \mathrm{dBFS}$ | 86 |  | dB |
|  |  | $\mathrm{f}_{\text {IN }}=10 \mathrm{MHz}, \mathrm{V}_{\text {IN }}=-0.5 \mathrm{dBFS}$ | 84 | -68 | dB (min) |
| IMD | Intermodulation Distortion | $\begin{aligned} & \mathrm{f}_{\mathrm{IN}}=9.5 \mathrm{MHz} \text { and } 10.5 \mathrm{MHz}, \\ & \text { each }=-8 \mathrm{dBFS} \end{aligned}$ | -75 |  | dBFS |

## Converter Electrical Characteristics (Continued)

Unless otherwise specified, the following specifications apply for AGND = DGND = DR GND $=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{A}}=\mathrm{V}_{\mathrm{D}}=+5 \mathrm{~V}, \mathrm{~V}_{\mathrm{DR}}=$ $+3.0 \mathrm{~V}, \mathrm{PD}=0 \mathrm{~V}, \mathrm{~V}_{\text {REF }}=+2.0 \mathrm{~V}, \mathrm{f}_{\text {CLK }}=40 \mathrm{MHz}, \mathrm{t}_{\mathrm{r}}=\mathrm{t}_{\mathrm{f}}=3 \mathrm{~ns}, \mathrm{C}_{\mathrm{L}}=20 \mathrm{pF} /$ pin. Boldface limits apply for $\mathrm{T}_{\mathrm{A}}=\mathrm{T}_{\mathrm{J}}=\mathrm{T}_{\text {MIN }}$ to $\mathrm{T}_{\text {MAX }}$ : all other limits $\mathrm{T}_{\mathrm{A}}=\mathrm{T}_{\mathrm{J}}=25^{\circ} \mathrm{C}$ (Notes 7, 8, 9)

| Symbol | Parameter | Conditions |  | Typical <br> (Note 10) | Limits <br> (Note 10) | Units <br> (Limits) |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| REFERENCE AND ANALOG INPUT CHARACTERISTICS |  |  |  |  |  |  |
| $\mathrm{V}_{\mathrm{CM}}$ | Common Mode Input Voltage |  |  | $\mathrm{V}_{\mathrm{A}} / 2$ |  | V |
| $\mathrm{C}_{\text {IN }}$ | $\mathrm{V}_{\mathrm{IN}}$ Input Capacitance (each pin to GND) | $\begin{aligned} & \mathrm{V}_{\mathrm{IN}}=2.5 \mathrm{Vdc} \\ & +0.7 \mathrm{~V}_{\mathrm{rms}} \end{aligned}$ | (CLK LOW) | 8 |  | pF |
|  |  |  | (CLK HIGH) | 7 |  | pF |
| $\mathrm{V}_{\text {REF }}$ | Reference Voltage (Note 13) |  |  |  | 1.0 | $V$ (min) |
|  |  |  |  | 2.00 | 2.2 |  |
|  | Reference Input Resistance |  |  | 100 |  | $\mathrm{M} \Omega$ (min) |

## DC and Logic Electrical Characteristics

Unless otherwise specified, the following specifications apply for AGND = DGND = DR GND $=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{A}}=\mathrm{V}_{\mathrm{D}}=+5 \mathrm{~V}, \mathrm{~V}_{\mathrm{DR}}=$ $+3.0 \mathrm{~V}, \mathrm{PD}=0 \mathrm{~V}, \mathrm{~V}_{\text {REF }}=+2.0 \mathrm{~V}, \mathrm{f}_{\mathrm{CLK}}=40 \mathrm{MHz}, \mathrm{t}_{\mathrm{r}}=\mathrm{t}_{\mathrm{f}}=3 \mathrm{~ns}, \mathrm{C}_{\mathrm{L}}=20 \mathrm{pF} /$ pin. Boldface limits apply for $\mathrm{T}_{\mathrm{A}}=\mathrm{T}_{\mathrm{J}}=\mathrm{T}_{\text {MIN }}$ to
$\mathrm{T}_{\text {MAX }}$ : all other limits $\mathrm{T}_{\mathrm{A}}=\mathrm{T}_{\mathrm{J}}=25^{\circ} \mathrm{C}$ (Notes 7, 8, 9)

| Symbol | Parameter | Conditions | Typical <br> $($ Note 10 $)$ | Limits <br> (Note 10) | Units <br> (Limits) |
| :---: | :---: | :---: | :---: | :---: | :---: |

## CLK, PD, OE DIGITAL INPUT CHARACTERISTICS

| $\mathrm{V}_{\mathrm{IN(1)}}$ | Logical "1" Input Voltage | $\mathrm{V}_{\mathrm{D}}=5.25 \mathrm{~V}$ |  | $\mathbf{2 . 0}$ | $\mathrm{~V}(\mathrm{~min})$ |
| :--- | :--- | :--- | :--- | :---: | :---: |
| $\mathrm{V}_{\mathrm{IN}(0)}$ | Logical "0" Input Voltage | $\mathrm{V}_{\mathrm{D}}=4.75 \mathrm{~V}$ |  | $\mathbf{1 . 0}$ | $\mathrm{~V}(\mathrm{max})$ |
| $\mathrm{I}_{\mathrm{IN}(1)}$ | Logical "1" Input Current | $\mathrm{V}_{\mathrm{IN}}=5.0 \mathrm{~V}$ | 10 |  | $\mu \mathrm{~A}$ |
| $\mathrm{I}_{\mathrm{IN}(0)}$ | Logical "0" Input Current | $\mathrm{V}_{\mathrm{IN}}=0 \mathrm{~V}$ | -10 |  | $\mu \mathrm{~A}$ |
| $\mathrm{C}_{\mathrm{IN}}$ | Digital Input Capacitance |  | 5 | pF |  |

D0-D11 DIGITAL OUTPUT CHARACTERISTICS

| $\mathrm{V}_{\text {OUT(1) }}$ | Logical "1" Output Voltage | $\mathrm{I}_{\text {OUT }}=-0.5 \mathrm{~mA}$ | $\mathrm{V}_{\mathrm{DR}}=2.5 \mathrm{~V}$ |  | 2.3 | V (min) |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | $\mathrm{V}_{\mathrm{DR}}=3 \mathrm{~V}$ |  | 2.7 | $V$ (min) |
| $\mathrm{V}_{\text {OUT(0) }}$ | Logical "0" Output Voltage | $\mathrm{I}_{\text {OUT }}=1.6 \mathrm{~mA}, \mathrm{~V}_{\mathrm{DR}}=3 \mathrm{~V}$ |  |  | 0.4 | V (max) |
| $\mathrm{I}_{\text {Oz }}$ | TRI-STATE Output Current | $\mathrm{V}_{\text {OUT }}=2.5 \mathrm{~V}$ or 5 V |  | 100 |  | nA |
|  |  | $\mathrm{V}_{\text {OUt }}=0 \mathrm{~V}$ |  | -100 |  | nA |
| ${ }_{+} \mathrm{l}_{\text {sc }}$ | Output Short Circuit Source Current | $\mathrm{V}_{\text {OUT }}=0 \mathrm{~V}$ |  | -20 |  | mA (min) |
| $-_{\text {ISC }}$ | Output Short Circuit Sink Current | $\mathrm{V}_{\text {OUT }}=\mathrm{V}_{\text {DR }}$ |  | 20 |  | mA (min) |
| POWER SUPPLY CHARACTERISTICS |  |  |  |  |  |  |
| $\mathrm{I}_{\mathrm{A}}$ | Analog Supply Current | $\begin{aligned} & \text { PD Pin }=\text { DGND, } V_{\text {REF }}=2.0 \mathrm{~V} \\ & \text { PD Pin }=V_{\text {DR }} \end{aligned}$ |  | $\begin{gathered} 59 \\ 8 \\ \hline \end{gathered}$ | 66 | $\begin{gathered} \mathrm{mA}(\max ) \\ \mathrm{mA} \end{gathered}$ |
| $\mathrm{I}_{\mathrm{D}}$ | Digital Supply Current | $\begin{aligned} & \text { PD Pin }=\text { DGND } \\ & \text { PD Pin }=V_{\text {DR }}, f_{\text {CLK }}=0 \end{aligned}$ |  | $\begin{aligned} & 6 \\ & 0 \end{aligned}$ | 7.3 | $\begin{gathered} \mathrm{mA}(\max ) \\ \mathrm{mA} \end{gathered}$ |
| $\mathrm{I}_{\mathrm{DR}}$ | Digital Output Supply Current | $\begin{aligned} & \text { PD Pin }=\text { DGND, } C_{L}=0 \mathrm{pF} \text { (Note 14) } \\ & \text { PD Pin }=V_{D R}, f_{\text {CLK }}=0 \end{aligned}$ |  | $\begin{aligned} & 3 \\ & 0 \end{aligned}$ |  | $\begin{gathered} \mathrm{mA}(\max ) \\ \mathrm{mA} \\ \hline \end{gathered}$ |
|  | Total Power Consumption | $\begin{aligned} & \text { PD Pin }=\text { DGND, } C_{L}=0 \mathrm{pF}(\text { Note 15 }) \\ & \text { PD Pin }=V_{D R}, f_{C L K}=0 \end{aligned}$ |  | $\begin{gathered} 340 \\ 40 \\ \hline \end{gathered}$ | 366 | $\begin{aligned} & \mathrm{mW} \\ & \mathrm{~mW} \\ & \hline \end{aligned}$ |
| PSRR1 | Power Supply Rejection | Rejection of Full-Scale Error with $\mathrm{V}_{\mathrm{A}}=4.75 \mathrm{~V}$ vs. 5.25 V |  | 58 |  | dB |
| PSRR2 | Power Supply Rejection | SNR Degradation w/10 MHz, $200 \mathrm{mV}_{\text {P-P }}$ riding on $\mathrm{V}_{\mathrm{A}}$ |  | 50 |  | dB |

## AC Electrical Characteristics

Unless otherwise specified，the following specifications apply for AGND＝DGND＝DR GND $=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{A}}=\mathrm{V}_{\mathrm{D}}=+5 \mathrm{~V}, \mathrm{~V}_{\mathrm{DR}}=$ $+3.0 \mathrm{~V}, \mathrm{PD}=0 \mathrm{~V}, \mathrm{~V}_{\text {REF }}=+2.0 \mathrm{~V}, \mathrm{f}_{\text {CLK }}=40 \mathrm{MHz}, \mathrm{t}_{\mathrm{r}}=\mathrm{t}_{\mathrm{f}}=3 \mathrm{~ns}, \mathrm{C}_{\mathrm{L}}=20 \mathrm{pF} /$ pin．Boldface limits apply for $\mathrm{T}_{\mathrm{A}}=\mathrm{T}_{\mathrm{J}}=\mathrm{T}_{\text {MIN }}$ to

| Symbol | Parameter | Conditions | Typical （Note 10） | Limits （Note 10） | Units （Limits） |
| :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{f}_{\text {CLK }}{ }^{1}$ | Maximum Clock Frequency |  | 50 | 40 | MHz（min） |
| $\mathrm{f}_{\text {CLK }}{ }^{\text {2 }}$ | Minimum Clock Frequency |  | 100 |  | kHz |
| $\mathrm{t}_{\mathrm{CH}}$ | Clock High Time |  |  | 11.25 | ns（min） |
| $\mathrm{t}_{\mathrm{CL}}$ | Clock Low Time |  |  | 11.25 | ns（min） |
| $\mathrm{t}_{\text {Conv }}$ | Conversion Latency |  |  | 6 | Clock <br> Cycles |
| $\mathrm{t}_{\mathrm{OD}}$ | Data Output Delay after Rising CLK Edge | $\mathrm{V}_{\mathrm{DR}}=2.5 \mathrm{~V}$ | 12 | $\begin{aligned} & \hline 16.3 \\ & 15.9 \end{aligned}$ | $\begin{aligned} & \text { ns (max) } \\ & \text { ns (min) } \end{aligned}$ |
|  |  | $\mathrm{V}_{\mathrm{DR}}=3.0 \mathrm{~V}$ | 11 | $\begin{aligned} & 15.7 \\ & 14.9 \end{aligned}$ | $\begin{aligned} & \hline \text { ns (max) } \\ & \text { ns (min) } \end{aligned}$ |
| $\mathrm{t}_{\mathrm{AD}}$ | Aperture Delay |  | 1.2 |  | ns |
| $\mathrm{t}_{\mathrm{AJ}}$ | Aperture Jitter |  | 1.2 |  | ps rms |
| $\mathrm{t}_{\text {DIS }}$ | Data outputs into TRI－STATE ${ }^{\text {TM Mode }}$ |  | 4 |  | ns |
| $\mathrm{t}_{\mathrm{EN}}$ | Data Outputs Active after TRI－STATE |  | 4 |  | ns |
| $\mathrm{t}_{\text {PD }}$ | Power Down Mode Exit Cycle |  | 20 |  | $\mathrm{t}_{\text {cLK }}$ |

Note 1：Absolute Maximum Ratings indicate limits beyond which damage to the device may occur．Operating Ratings indicate conditions for which the device is functional，but do not guarantee specific performance limits．For guaranteed specifications and test conditions，see the Electrical Characteristics．The guaranteed specifications apply only for the test conditions listed．Some performance characteristics may degrade when the device is not operated under the listed test conditions．
Note 2：All voltages are measured with respect to $G N D=A G N D=D G N D=0 V$ ，unless otherwise specified．
Note 3：When the input voltage at any pin exceeds the power supplies（that is， $\mathrm{V}_{I N}<A G N D$ ，or $\mathrm{V}_{I N}>\mathrm{V}_{\mathrm{A}}$ ），the current at that pin should be limited to 25 mA ．The 50 mA maximum package input current rating limits the number of pins that can safely exceed the power supplies with an input current of 25 mA to two．
Note 4：The absolute maximum junction temperature（ $T_{\jmath} \max$ ）for this device is $150^{\circ} \mathrm{C}$ ．The maximum allowable power dissipation is dictated by $T_{\jmath m a x}$ ，the junction－to－ambient thermal resistance（ $\theta_{J A}$ ），and the ambient temperature，（ $T_{A}$ ），and can be calculated using the formula $P_{D} M A X=\left(T_{J} m a x-T_{A}\right) / \theta_{J A}$ ．In the $32-p i n$ LQFP，$\theta_{J A}$ is $79^{\circ} \mathrm{C} / \mathrm{W}$ ，so $P_{D} M A X=1,582 \mathrm{~mW}$ at $25^{\circ} \mathrm{C}$ and 823 mW at the maximum operating ambient temperature of $85^{\circ} \mathrm{C}$ ．Note that the power consumption of this device under normal operation will typically be about 360 mW （ 340 typical power consumption +20 mW TTL output loading）．The values for maximum power dissipation listed above will be reached only when the device is operated in a severe fault condition（e．g．when input or output pins are driven beyond the power supply voltages，or the power supply polarity is reversed）．Obviously，such conditions should always be avoided．
Note 5：Human body model is 100 pF capacitor discharged through a $1.5 \mathrm{k} \Omega$ resistor．Machine model is 220 pF discharged through $0 \Omega$ ．
Note 6：The $235^{\circ} \mathrm{C}$ reflow temperature refers to infrared reflow．For Vapor Phase Reflow（VPR），the following Conditions apply：Maintain the temperature at the top of the package body above $183^{\circ} \mathrm{C}$ for a minimum 60 seconds．The temperature measured on the package body must not exceed $220^{\circ} \mathrm{C}$ ．Only one excursion above $183^{\circ} \mathrm{C}$ is allowed per reflow cycle．
Note 7：The inputs are protected as shown below．Input voltage magnitudes above $\mathrm{V}_{\mathrm{A}}$ or below GND will not damage this device，provided current is limited per （Note 3）．However，errors in the $\mathrm{A} / \mathrm{D}$ conversion can occur if the input goes above $\mathrm{V}_{\mathrm{A}}$ or below GND by more than 100 mV ．As an example，if $\mathrm{V}_{\mathrm{A}}$ is 4.75 V ，the full－scale input voltage must be $\leq 4.85 \mathrm{~V}$ to ensure accurate conversions．


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Note 8：To guarantee accuracy，it is required that $\left|V_{A}-V_{D}\right| \leq 100 \mathrm{mV}$ and separate bypass capacitors are used at each power supply pin．
Note 9：With the test condition for $\mathrm{V}_{\mathrm{REF}}=+2.0 \mathrm{~V}$（ $4 \mathrm{~V}_{\text {P－P }}$ differential input），the 12－bit LSB is $977 \mu \mathrm{~V}$ ．

## AC Electrical Characteristics (Continued)

Note 10: Typical figures are at $\mathrm{T}_{\mathrm{A}}=\mathrm{T}_{\mathrm{J}}=25^{\circ} \mathrm{C}$, and represent most likely parametric norms. Test limits are guaranteed to National's AOQL (Average Outgoing Quality Level).
Note 11: Integral Non Linearity is defined as the deviation of the analog value, expressed in LSBs, from the straight line that passes through positive and negative full-scale.
Note 12: Timing specifications are tested at TTL logic levels, $\mathrm{V}_{\mathrm{IL}}=0.4 \mathrm{~V}$ for a falling edge and $\mathrm{V}_{\mathrm{IH}}=2.4 \mathrm{~V}$ for a rising edge.
Note 13: Optimum performance will be obtained by keeping the reference input in the 1.8 V to 2.2 V range. The LM4051CIM3-ADJ (SOT-23 package) is recommended for this application.
Note 14: $I_{D R}$ is the current consumed by the switching of the output drivers and is primarily determined by load capacitance on the output pins, the supply voltage, $V_{D R}$, and the rate at which the outputs are switching (which is signal dependent). $I_{D R}=V_{D R}\left(C_{0} \times f_{0}+C_{1} \times f_{1}+\ldots . C_{11} \times f_{11}\right)$ where $V_{D R}$ is the output driver power supply voltage, $C_{n}$ is total capacitance on the output pin, and $f_{n}$ is the average frequency at which that pin is toggling.
Note 15: Excludes IDR. See note 14.

## Specification Definitions

APERTURE DELAY is the time after the rising edge of the clock to when the input signal is acquired or held for conversion.
APERTURE JITTER (APERTURE UNCERTAINTY) is the variation in aperture delay from sample to sample. Aperture jitter manifests itself as noise in the output.
COMMON MODE VOLTAGE ( $\mathrm{V}_{\mathbf{c m}}$ ) is the d.c. potential present at both signal inputs to the ADC.
CONVERSION LATENCY See PIPELINE DELAY.
DIFFERENTIAL NON-LINEARITY (DNL) is the measure of the maximum deviation from the ideal step size of 1 LSB.
DUTY CYCLE is the ratio of the time during one cycle that a repetitive digital waveform is high to the total time of one period. The specification here refers to the ADC clock input signal.
EFFECTIVE NUMBER OF BITS (ENOB, or EFFECTIVE BITS) is another method of specifying Signal-to-Noise and Distortion or SINAD. ENOB is defined as (SINAD - 1.76) / 6.02 and says that the converter is equivalent to a perfect ADC of this (ENOB) number of bits.
FULL POWER BANDWIDTH is a measure of the frequency at which the reconstructed output fundamental drops 3 dB below its low frequency value for a full scale input.
GAIN ERROR is the deviation from the ideal slope of the transfer function. It can be calculated as:

Gain Error = Positive Full Scale Error - Offset Error
INTEGRAL NON LINEARITY (INL) is a measure of the deviation of each individual code from a line drawn from negative full scale ( $1 / 2$ LSB below the first code transition) through positive full scale ( $1 / 2$ LSB above the last code transition). The deviation of any given code from this straight line is measured from the center of that code value.
INTERMODULATION DISTORTION (IMD) is the creation of additional spectral components as a result of two sinusoidal frequencies being applied to the ADC input at the same time. It is defined as the ratio of the power in the intermodulation products to the total power in the original frequencies. IMD is usually expressed in dBFS.
MISSING CODES are those output codes that will never appear at the ADC outputs. The ADC12040 is guaranteed not to have any missing codes.

NEGATIVE FULL SCALE ERROR is the difference between the actual first code transition and its ideal value of $1 / 2$ LSB above negative full scale.
OFFSET ERROR is the difference between the two input voltages ( $\mathrm{V}_{\mathrm{IN}}+-\mathrm{V}_{\mathrm{IN}}{ }^{-}$) required to cause a transition from code 2047 to 2048.
OUTPUT DELAY is the time delay after the rising edge of the clock before the data update is presented at the output pins.
PIPELINE DELAY (LATENCY) is the number of clock cycles between initiation of conversion and when that data is presented to the output driver stage. Data for any given sample is available at the output pins the Pipeline Delay plus the Output Delay after the sample is taken. New data is available at every clock cycle, but the data lags the conversion by the pipeline delay.
POSITIVE FULL SCALE ERROR is the difference between the actual last code transition and its ideal value of $11 / 2$ LSB below positive full scale.
POWER SUPPLY REJECTION RATIO (PSRR) is a measure of how well the ADC rejects a change in the power supply voltage. For the ADC12040, PSRR1 is the ratio of the change in Full-Scale Error that results from a change in the dc power supply voltage, expressed in dB. PSRR2 is a measure of how well an a.c. signal riding upon the power supply is rejected at the output.
SIGNAL TO NOISE RATIO (SNR) is the ratio, expressed in dB , of the rms value of the input signal to the rms value of the sum of all other spectral components below one-half the sampling frequency, not including harmonics or dc,
SIGNAL TO NOISE PLUS DISTORTION (S/N+D or SINAD) Is the ratio, expressed in dB , of the rms value of the input signal to the rms value of all of the other spectral components below half the clock frequency, including harmonics but excluding dc.
SPURIOUS FREE DYNAMIC RANGE (SFDR) is the difference, expressed in dB , between the rms values of the input signal and the peak spurious signal, where a spurious signal is any signal present in the output spectrum that is not present at the input.
TOTAL HARMONIC DISTORTION (THD) is the ratio, expressed in dB or dBc , of the rms total of the first six harmonic components to the rms value of the input signal.

## Timing Diagram



## Transfer Characteristic



FIGURE 1. Transfer Characteristic

Typical Performance Characteristics $\mathrm{V}_{\mathrm{A}}=\mathrm{V}_{\mathrm{D}}=5 \mathrm{~V}, \mathrm{~V}_{\mathrm{DR}}=3 \mathrm{~V}, \mathrm{f}_{\mathrm{CLK}}=40 \mathrm{MHz}, \mathrm{f}_{\mathrm{IN}}=10 \mathrm{MHz}$ unless otherwise stated


DNL vs. Temperature


INL


DNL vs. $\mathrm{V}_{\mathrm{A}}$


20014821

## DNL vs. Clock Duty Cycle



INL vs. $\mathrm{V}_{\mathrm{A}}$


Typical Performance Characteristics $\mathrm{V}_{\mathrm{A}}=\mathrm{V}_{\mathrm{D}}=5 \mathrm{~V}, \mathrm{~V}_{\mathrm{DR}}=3 \mathrm{~V}, \mathrm{f}_{\mathrm{CLK}}=40 \mathrm{MHz}, \mathrm{f}_{\mathrm{IN}}=10 \mathrm{MHz}$ unless otherwise stated (Continued)

INL vs. Temperature


SNR vs. Temperature


SINAD vs. Temperature


INL vs. Clock Duty Cycle


20014827
THD vs. Temperature


SNR vs. Clock Duty Cycle


20014825
20014831

Typical Performance Characteristics $\mathrm{V}_{\mathrm{A}}=\mathrm{V}_{\mathrm{D}}=5 \mathrm{~V}, \mathrm{~V}_{\mathrm{DR}}=3 \mathrm{~V}, \mathrm{f}_{\mathrm{CLK}}=40 \mathrm{MHz}, \mathrm{f}_{\mathrm{IN}}=10 \mathrm{MHz}$ unless otherwise stated (Continued)

THD vs. Clock Duty Cycle




20014833


## Functional Description

Operating on a single +5 V supply, the ADC12040 uses a pipeline architecture and has error correction circuitry to help ensure maximum performance. The differential analog input signal is digitized to 12 bits.
The reference input is buffered to ease the task of driving that pin.
The output word rate is the same as the clock frequency, which can be between 100 kSPS and 50 MSPS (typical). The analog input voltage is acquired at the rising edge of the clock and the digital data for a given sample is delayed by the pipeline for 6 clock cycles.
A logic high on the power down (PD) pin reduces the converter power consumption to 70 mW .

## Applications Information

### 1.0 OPERATING CONDITIONS

We recommend that the following conditions be observed for operation of the ADC12040:

$$
\begin{aligned}
& 4.75 \mathrm{~V} \leq \mathrm{V}_{\mathrm{A}} \leq 5.25 \mathrm{~V} \\
& \mathrm{~V}_{\mathrm{D}}=\mathrm{V}_{\mathrm{A}} \\
& 2.35 \mathrm{~V} \leq \mathrm{V}_{\mathrm{DR}} \leq \mathrm{V}_{\mathrm{D}} \\
& 100 \mathrm{kHz} \leq \mathrm{f}_{\mathrm{CLK}} \leq 50 \mathrm{MHz} \\
& 1.0 \mathrm{~V} \leq \mathrm{V}_{\text {REF }} \leq 2.2 \mathrm{~V}
\end{aligned}
$$

### 1.1 ANALOG INPUTS

The ADC12040 has two analog signal inputs, $\mathrm{V}_{\mathrm{IN}^{+}}$and $\mathrm{V}_{\mathrm{IN}^{-}}$. These two pins form a differential input pair. There is one reference input pin, $\mathrm{V}_{\text {REF }}$.

### 1.2 REFERENCE PINS

The ADC12040 is designed to operate with a 2.0 V reference, but performs well with reference voltages in the range of 1.0 V to 2.2 V . Lower reference voltages will decrease the signal-to-noise ratio (SNR) of the ADC12040. Increasing the reference voltage (and the input signal swing) beyond 2.2 V will degrade THD for a full-scale input. It is very important that all grounds associated with the reference voltage and the input signal make connection to the analog ground plane at a single point to minimize the effects of noise currents in the ground path.
The three Reference Bypass Pins ( $\mathrm{V}_{\mathrm{RP}}, \mathrm{V}_{\mathrm{RM}}$ and $\mathrm{V}_{\mathrm{RN}}$ ) are made available for bypass purposes only. These pins should each be bypassed to ground with a $0.1 \mu \mathrm{~F}$ capacitor. DO NOT LOAD these pins.

### 1.3 SIGNAL INPUTS

The signal inputs are $\mathrm{V}_{\mathrm{IN}^{+}}$and $\mathrm{V}_{\mathrm{IN}^{-}}$. The input signal, $\mathrm{V}_{\mathbb{I N}}$, is defined as

$$
\mathrm{V}_{\mathrm{IN}}=\left(\mathrm{V}_{\mathrm{IN}^{+}}\right)-\left(\mathrm{V}_{\mathrm{IN}^{-}}\right)
$$

Figure 2 shows the expected input signal range.
Note that the common mode input voltage range is 1 V to 3 V with a nominal value of $\mathrm{V}_{\mathrm{A}} / 2$. The input signals should remain between ground and 4 V .
The Peaks of the individual input signals ( $\mathrm{V}_{\mathrm{IN}^{+}}$and $\mathrm{V}_{1 \mathrm{~N}^{-}}$) should each never exceed the voltage described as

$$
\mathrm{V}_{\mathrm{IN}^{+}}, \mathrm{V}_{\mathrm{IN}^{-}}=\mathrm{V}_{\mathrm{REF}} / 2+\mathrm{V}_{\mathrm{CM}} \leq 4 \mathrm{~V} \text { (differential) }
$$

to maintain THD and SINAD performance.

(a) Differential Input

(b) Single-Ended Input

20014811

## FIGURE 2. Expected Input Signal Range

The ADC12040 performs best with a differential input with each input centered around $\mathrm{V}_{\mathrm{CM}}$. The peak-to-peak voltage swing at both $\mathrm{V}_{\mathrm{IN}^{+}}$and $\mathrm{V}_{\mathrm{IN}^{-}}$should not exceed the value of the reference voltage or the output data will be clipped. The two input signals should be exactly $180^{\circ}$ out of phase from each other and of the same amplitude. For single frequency inputs, angular errors result in a reduction of the effective full scale input. For a complex waveform, however, angular errors will result in distortion.

For angular deviations of up to 10 degrees from these two signals being 180 out of phase, the full scale error in LSB can be described as approximately

$$
\mathrm{E}_{\mathrm{FS}}=\operatorname{dev}^{1.79}
$$

Where dev is the angular difference between the two signals having a $180^{\circ}$ relative phase relationship to each other (see Figure 3). Drive the analog inputs with a source impedance less than $100 \Omega$.


## FIGURE 3. Angular Errors Between the Two Input Signals Will Reduce the Output Level

For differential operation, each analog input signal should have a peak-to-peak voltage equal to the input reference voltage, $\mathrm{V}_{\mathrm{REF}}$, and be centered around $\mathrm{V}_{\mathrm{CM}}$.

TABLE 1. Input to Output RelationshipDifferential Input

| $\mathrm{V}_{\text {IN }}$ | $\mathrm{V}_{\text {IN }}$ | Output |
| :---: | :---: | :---: |
| $\mathrm{V}_{\mathrm{CM}}-\mathrm{V}_{\text {REF }} / 2$ | $\mathrm{~V}_{\mathrm{CM}}+\mathrm{V}_{\text {REF }} / 2$ | 000000000000 |
| $\mathrm{~V}_{\mathrm{CM}}-\mathrm{V}_{\text {REF }} / 4$ | $\mathrm{~V}_{\mathrm{CM}}+\mathrm{V}_{\text {REF }} / 4$ | 010000000000 |
| $\mathrm{~V}_{\mathrm{CM}}$ | $\mathrm{V}_{\mathrm{CM}}$ | 100000000000 |
| $\mathrm{~V}_{\mathrm{CM}}+\mathrm{V}_{\text {REF }} / 2$ | $\mathrm{~V}_{\mathrm{CM}}-\mathrm{V}_{\text {REF }} / 4$ | 110000000000 |
| $\mathrm{~V}_{\mathrm{CM}}+\mathrm{V}_{\text {REF }} / 2$ | $\mathrm{~V}_{\mathrm{CM}}-\mathrm{V}_{\text {RE/2F }}$ | 11111111111 |

## Applications Information (Continued)

## TABLE 2. Input to Output Relationship-Single-Ended Input

| $\mathbf{V}_{\text {IN }^{+}}$ | $\mathbf{V}_{\text {IN }}$ | Output |
| :---: | :---: | :---: |
| $\mathrm{V}_{\mathrm{CM}}-\mathrm{V}_{\text {REF }}$ | $\mathrm{V}_{\mathrm{CM}}$ | 000000000000 |
| $\mathrm{~V}_{\mathrm{CM}}-\mathrm{V}_{\text {REF }} / 2$ | $\mathrm{~V}_{\mathrm{CM}}$ | 010000000000 |
| $\mathrm{~V}_{\text {CM }}$ | $\mathrm{V}_{\mathrm{CM}}$ | 100000000000 |
| $\mathrm{~V}_{\mathrm{CM}}+\mathrm{V}_{\text {REF }} / 2$ | $\mathrm{~V}_{\mathrm{CM}}$ | 110000000000 |
| $\mathrm{~V}_{\mathrm{CM}}+\mathrm{V}_{\text {REF }}$ | $\mathrm{V}_{\mathrm{CM}}$ | 111111111111 |

### 1.3.1 Single-Ended Operation

single-ended performance is lower than with differential input signals, so single-ended operation is not recommended. However, if single-ended operation is required, one of the analog inputs should be connected to the d.c. common mode voltage of the driven input. The peak-to-peak differential input signal should be twice the reference voltage to maximize SNR and SINAD performance (Figure 2b).
For example, set $\mathrm{V}_{\text {REF }}$ to 1.0 V and bias $\mathrm{V}_{\mathrm{IN}^{-}}$to 1.0 V and drive $\mathrm{V}_{\mathrm{IN}^{+}}$with a signal range of 0 V to 2.0 V .
Because very large input signal swings can degrade distortion performance, better performance with a single-ended input can be obtained by reducing the reference voltage while maintaining a full-range output. Table 1 and Table 2 indicate the input to output relationship of the ADC12040.

### 1.3.2 Driving the Analog Inputs

The $\mathrm{V}_{\mathrm{IN}^{+}}$and the $\mathrm{V}_{\mathrm{IN}^{-}}$inputs of the ADC12040 consist of an analog switch followed by a switched-capacitor amplifier. The capacitance seen at the analog input pins changes with the clock level, appearing as 8 pF when the clock is low, and 7 pF when the clock is high. Although this difference is small, a dynamic capacitance is more difficult to drive than is a fixed capacitance, so choose the driving amplifier carefully. The LMH6702 is a good amplifier for driving the ADC12040. The internal switching action at the analog inputs causes energy to be output from the input pins. As the driving source tries to compensate for this, it adds noise to the signal. To prevent this, use $33 \Omega$ series resistors at each of the signal inputs with a 10 pF capacitor across the inputs, as can be seen in Figure 5 and Figure 6. These components should be placed close to the ADC because the input pins of the ADC is the most sensitive part of the system and this is the last opportunity to filter the input. The 10 pF capacitor is for undersampling applications and should be replaced with a 68 pF capacitor for Nyquist applications.
Table 3 gives component values for Figure 5 to convert signals to a range of $2.0 \mathrm{~V} \pm 1.0 \mathrm{~V}$ at each of the differential input pins of the ADC12040, assuming a $\mathrm{V}_{\text {REF }}$ of 2.0V.

TABLE 3. Resistor Values for Circuit of Figure 5

| SIGNAL <br> RANGE | R1 | R2 | R3 | R4 | R5, R6 |
| :---: | :---: | :---: | :---: | :---: | :---: |
| $0-0.5 \mathrm{~V}$ | $392 \Omega$ | $1540 \Omega$ | $102 \Omega$ | $115 \Omega$ | $1000 \Omega$ |
| $0-1.0 \mathrm{~V}$ | $634 \Omega$ | $1470 \Omega$ | $2490 \Omega$ | $1050 \Omega$ | $499 \Omega$ |
| $\pm 0.25 \mathrm{~V}$ | $499 \Omega$ | $499 \Omega$ | $499 \Omega$ | $499 \Omega$ | $1000 \Omega$ |
| $\pm 0.5 \mathrm{~V}$ | $100 \Omega$ | $200 \Omega$ | $100 \Omega$ | $200 \Omega$ | $499 \Omega$ |

### 1.3.3 Input Common Mode Voltage

The input common mode voltage, $\mathrm{V}_{\mathrm{CM}}$, should be in the range of 0.4 V to 4.0 V and be of a value such that the peak excursions of the analog input signal do not go more negative than ground or more positive than 1 V below the $\mathrm{V}_{\mathrm{A}}$ supply voltage. The nominal $\mathrm{V}_{\mathrm{CM}}$ should generally be equal to $\mathrm{V}_{\text {REF }} / 2$, but $\mathrm{V}_{\mathrm{RM}}$ can be used as a $\mathrm{V}_{\mathrm{CM}}$ source as long as $\mathrm{V}_{\mathrm{RM}}$ need not supply more than $10 \mu \mathrm{~A}$ of current.

### 2.0 DIGITAL INPUTS

Digital inputs consist of CLK, $\overline{O E}$ and PD.

### 2.1 CLK

The CLK signal controls the timing of the sampling process. Drive the clock input with a stable, low jitter clock signal in the range of 100 kHz to 50 MHz with rise and fall times of less than 3ns. The trace carrying the clock signal should be as short as possible and should not cross any other signal line, analog or digital, not even at $90^{\circ}$.
If the CLK is interrupted, or its frequency too low, the charge on internal capacitors can dissipate to the point where the accuracy of the output data will degrade. This is what limits the lowest sample rate to 100 kSPS .
The CLK pin should be terminated with a series $100 \Omega$ resistor and 51 pF capacitor to ground located within two centimeters of the ADC12040 clock pin, as shown in Figure 4. Whenever the trace between the clock source and the ADC clock pin is greater than 1 cm , use a $50 \Omega$ series resistor in the clock line, located within 1 cm of the driving source.

## $2.2 \overline{\mathrm{OE}}$

The $\overline{\mathrm{OE}}$ pin, when high, puts the output pins into a high impedance state. When this pin is low the outputs are in the active state. The ADC12040 will continue to convert whether this pin is high or low, but the output can not be read while the $\overline{\mathrm{OE}}$ pin is high.

### 2.3 PD

The PD pin, when high, holds the ADC12040 in a powerdown mode to conserve power when the converter is not being used. The power consumption in this state is 70 mW with a 40 MHz clock and 40 mW if the clock is stopped. The output data pins are undefined in this mode. The data in the pipeline is corrupted while in the power down mode.

### 3.0 OUTPUTS

The ADC12040 has 12 TTL/CMOS compatible Data Output pins. Valid data is present at these outputs while the $\overline{\mathrm{OE}}$ and PD pins are low. While the $t_{O D}$ time provides information about output timing, a simple way to capture a valid output is to latch the data on the falling edge of the conversion clock (pin 10). The output data format is offset binary.
Be very careful when driving a high capacitance bus. The more capacitance the output drivers must charge for each conversion, the more instantaneous digital current flows through $\mathrm{V}_{\mathrm{DR}}$ and DR GND. These large charging current spikes can cause on-chip ground noise and couple into the analog circuitry, degrading dynamic performance. Adequate bypassing and careful attention to the ground plane will reduce this problem. Additionally, bus capacitance beyond the specified $20 \mathrm{pF} / \mathrm{pin}$ will cause $\mathrm{t}_{\mathrm{OD}}$ to increase, making it difficult to properly latch the ADC output data. The result could be an apparent reduction in dynamic performance.
To minimize noise due to output switching, minimize the load currents at the digital outputs. This can be done by connect-

## Applications Information (Continued)

ing buffers between the ADC outputs and any other circuitry (74ACQ541, for example). Only one input should be connected to each output pin. Additionally, inserting series re-
sistors of $47 \Omega$ to $100 \Omega$ at the digital outputs, close to the ADC pins, will isolate the outputs from trace and other circuit capacitances and limit the output currents, which could otherwise result in performance degradation. See Figure 4.


FIGURE 4. Simple Application Circuit with Single-Ended to Differential Buffer


FIGURE 5. Differential Drive Circuit of Figure 4

## Applications Information (Continued)



FIGURE 6. Driving the Signal Inputs with a Transformer

### 4.0 POWER SUPPLY CONSIDERATIONS

The power supply pins should be bypassed with a $10 \mu \mathrm{~F}$ capacitor and with a $0.1 \mu \mathrm{~F}$ ceramic chip capacitor within a centimeter of each power pin. Leadless chip capacitors are preferred because they have low series inductance.
As is the case with all high-speed converters, the ADC12040 is sensitive to power supply noise. Accordingly, the noise on the analog supply pin should be kept below 100 mV P-p.
No pin should ever have a voltage on it that is in excess of the supply voltages, not even on a transient basis. Be especially careful of this during turn on and turn off of power.
The $\mathrm{V}_{\mathrm{DR}}$ pin provides power for the output drivers and may be operated from a supply in the range of 2.35 V to $\mathrm{V}_{\mathrm{D}}$ (nominal 5V). This can simplify interfacing to 3 V devices and systems. DO NOT operate the $\mathrm{V}_{\mathrm{DR}}$ pin at a voltage higher than $\mathrm{V}_{\mathrm{D}}$.

### 5.0 LAYOUT AND GROUNDING

Proper grounding and proper routing of all signals are essential to ensure accurate conversion. Maintaining separate analog and digital areas of the board, with the ADC12040 between these areas, is required to achieve specified performance.
The ground return for the data outputs (DR GND) carries the ground current for the output drivers. The output current can exhibit high transients that could add noise to the conversion
process. To prevent this from happening, the DR GND pins should NOT be connected to system ground in close proximity to any of the ADC12040's other ground pins.
Capacitive coupling between the typically noisy digital circuitry and the sensitive analog circuitry can lead to poor performance. The solution is to keep the analog circuitry separated from the digital circuitry, and to keep the clock line as short as possible.
Digital circuits create substantial supply and ground current transients. The logic noise thus generated could have significant impact upon system noise performance. The best logic family to use in systems with A/D converters is one which employs non-saturating transistor designs, or has low noise characteristics, such as the $74 \mathrm{LS}, 74 \mathrm{HC}(\mathrm{T})$ and 74AC(T)Q families. The worst noise generators are logic families that draw the largest supply current transients during clock or signal edges, like the 74F and the 74AC(T) families.
The effects of the noise generated from the ADC output switching can be minimized through the use of $47 \Omega$ to $100 \Omega$ resistors in series with each data output line. Locate these resistors as close to the ADC output pins as possible.
Since digital switching transients are composed largely of high frequency components, total ground plane copper weight will have little effect upon the logic-generated noise. This is because of the skin effect. Total surface area is more important than is total ground plane volume.

## Applications Information（Continued）

Generally，analog and digital lines should cross each other at $90^{\circ}$ to avoid crosstalk．To maximize accuracy in high speed， high resolution systems，however，avoid crossing analog and digital lines altogether．It is important to keep clock lines as short as possible and isolated from ALL other lines，including other digital lines．Even the generally accepted $90^{\circ}$ crossing should be avoided with the clock line as even a little coupling
can cause problems at high frequencies．This is because other lines can introduce jitter into the clock line，which can lead to degradation of SNR．Also，the high speed clock can introduce noise into the analog chain．
Best performance at high frequencies and at high resolution is obtained with a straight signal path．That is，the signal path through all components should form a straight line wherever possible．


FIGURE 7．Example of a Suitable Layout

Be especially careful with the layout of inductors．Mutual inductance can change the characteristics of the circuit in which they are used．Inductors should not be placed side by side，even with just a small part of their bodies beside each other．
The analog input should be isolated from noisy signal traces to avoid coupling of spurious signals into the input．Any external component（e．g．，a filter capacitor）connected be－ tween the converter＇s input pins and ground or to the refer－ ence input pin and ground should be connected to a very clean point in the analog ground plane．
Figure 7 gives an example of a suitable layout．All analog circuitry（input amplifiers，filters，reference components，etc．） should be placed over the analog ground plane．All digital circuitry and I／O lines should be placed over the digital ground plane．Furthermore，all components in the reference circuitry and the input signal chain that are connected to ground should be connected together with short traces and enter the analog ground plane at a single point．All ground connections should have a low inductance path to ground．

## 6．0 DYNAMIC PERFORMANCE

To achieve the best dynamic performance，the clock source driving the CLK input must be free of jitter．Isolate the ADC clock from any digital circuitry with buffers，as with the clock tree shown in Figure 8.
As mentioned in Section 5．0，it is good practice to keep the ADC clock line as short as possible and to keep it well away from any other signals．Other signals can introduce jitter into the clock signal，which can lead to reduced SNR perfor－
mance，and the clock can introduce noise into other lines． Even lines with $90^{\circ}$ crossings have capacitive coupling，so try to avoid even these $90^{\circ}$ crossings of the clock line．


20014817
FIGURE 8．Isolating the ADC Clock from other Circuitry with a Clock Tree

## 7．0 COMMON APPLICATION PITFALLS

Driving the inputs（analog or digital）beyond the power supply rails．For proper operation，all inputs should not go more than 100 mV beyond the supply rails（more than 100 mV below the ground pins or 100 mV above the supply pins）．Exceeding these limits on even a transient basis may cause faulty or erratic operation．It is not uncommon for high

## Applications Information (Continued)

speed digital components (e.g., 74F and 74AC devices) to exhibit overshoot or undershoot that goes above the power supply or below ground. A resistor of about $50 \Omega$ to $100 \Omega$ in series with any offending digital input, close to the signal source, will eliminate the problem.
Do not allow input voltages to exceed the supply voltage, even on a transient basis. Not even during power up or power down.
Be careful not to overdrive the inputs of the ADC12040 with a device that is powered from supplies outside the range of the ADC12040 supply. Such practice may lead to conversion inaccuracies and even to device damage.
Attempting to drive a high capacitance digital data bus. The more capacitance the output drivers must charge for each conversion, the more instantaneous digital current flows through $\mathrm{V}_{\mathrm{DR}}$ and DR GND. These large charging current spikes can couple into the analog circuitry, degrading dynamic performance. Adequate bypassing and maintaining separate analog and digital areas on the pc board will reduce this problem.
Additionally, bus capacitance beyond the specified $20 \mathrm{pF} /$ pin will cause $t_{O D}$ to increase, making it difficult to properly latch the ADC output data. The result could, again, be an apparent reduction in dynamic performance.
The digital data outputs should be buffered (with 74ACQ541, for example). Dynamic performance can also be improved by adding series resistors at each digital output, close to the ADC12040, which reduces the energy coupled back into the converter output pins by limiting the output current. A reasonable value for these resistors is $47 \Omega$ to $100 \Omega$.

Using an inadequate amplifier to drive the analog input. As explained in Section 1.3, the capacitance seen at the input alternates between 8 pF and 7 pF , depending upon the phase of the clock. This dynamic load is more difficult to drive than is a fixed capacitance.
If the amplifier exhibits overshoot, ringing, or any evidence of instability, even at a very low level, it will degrade performance. A small series resistor at each amplifier output and a capacitor across the analog inputs (as shown in Figures 5, 6) will improve performance. The CLC409 has been successfully used to drive the analog inputs of the ADC12040.
Also, it is important that the signals at the two inputs have exactly the same amplitude and be exactly $180^{\circ}$ out of phase with each other. Board layout, especially equality of the length of the two traces to the input pins, will affect the effective phase between these two signals. Remember that an operational amplifier operated in the non-inverting configuration will exhibit more time delay than will the same device operating in the inverting configuration.
Operating with the reference pins outside of the specified range. As mentioned in Section 1.2, $\mathrm{V}_{\text {REF }}$ should be in the range of

$$
1.0 \mathrm{~V} \leq \mathrm{V}_{\text {REF }} \leq 2.2 \mathrm{~V}
$$

Operating outside of these limits could lead to performance degradation.
Using a clock source with excessive jitter, using excessively long clock signal trace, or having other signals coupled to the clock signal trace. This will cause the sampling interval to vary, causing excessive output noise and a reduction in SNR and SINAD performance.

Physical Dimensions inches (millimeters) unless otherwise noted


VBE32A (Rev E)

32-Lead LQFP Package
Ordering Number ADC12040CIVY
NS Package Number VBE32A

## LIFE SUPPORT POLICY

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